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SPECIFICATION FOR LCM MODULE

MODULE NO.: AVD-T320240C256-02-R **DOC. REVISION01**

	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)		
PREPARED BY (QA ENGINEER)		
CHECKED BY		
APPROVED BY		

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1. Functions & Features

1.1. Format : 320x240 Dots

1.2. LCD mode : Normally White, Transmissive

1.3. Viewing direction: 6 O'clock1.4. Display color: 256 colors1.5. Operation temp: $-20\sim70^{\circ}$ C1.6. Storage temp: $-30\sim80^{\circ}$ C1.7. Power supply voltage (V_{DD}): 3.3V1.8. LED power voltage: 5.0V

1.9. Backlight color : White(LED) 1.10 LCM Contrast ratio : 300:1

1.11 LCM Birghtness : 200 nit(tye)

1.12.RoHS standard

2. MECHANICAL SPECIFICATIONS

2.1. Module size : 92.0mm(L)*78.4mm(W)*10.5(Max) mm (H)

2.2. Viewing area : 73.3mm(L)*55.8mm(W) 2.3. Pixel size : 73.0um(W)*219.0um(H)

2.4. Weight : Approx.

3. BLOCK DIAGRAM

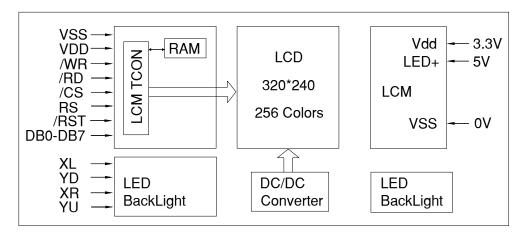


Figure 1. Block diagram

4. DIMENSIONAL OUTLINE

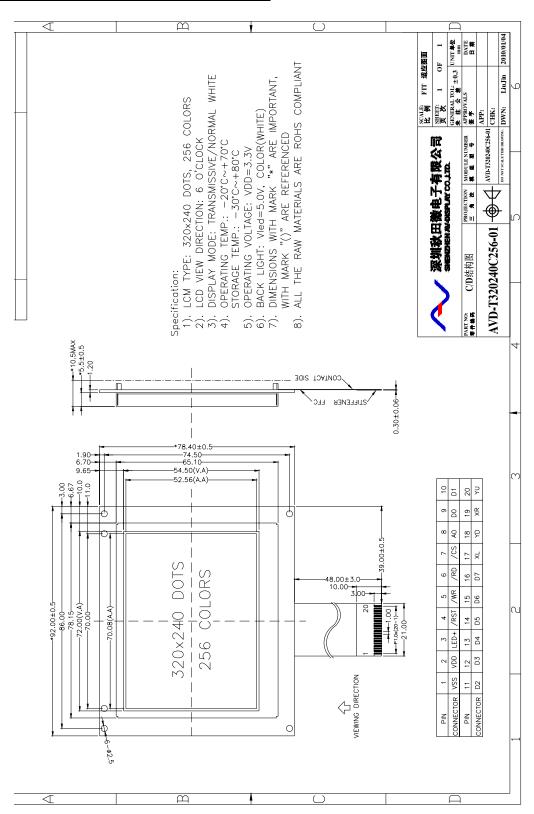


Figure 2. Dimensional outline



5. PIN DESCRIPTION

No.	Symbol	Function
1	VSS	GND
2	VDD	Logic supply voltage (3.3V)
3	LED+	Power supply for backlight(+5.0V)
4	/RST	Reset signal (L)
5	/WR	Write signal
6	/RD	Read signal
7	/CS	Chip enable signal
8	A0	Register selection (H:Data register, L:Instruction register)
9	D0	Data bus line
10	D1	Data bus line
11	D2	Data bus line
12	D3	Data bus line
13	D4	Data bus line
14	D5	Data bus line
15	D6	Data bus line
16	D7	Data bus line
17	XL	
18	YD	
19	XR	
20	YU	

6. MAXIMUM ABSOUTE LIMIT

Item	Symbol	MIN	MAX	Unit
Supply Voltage for Logic	$V_{ m DD}$	-0.3	5.0	V
Input Voltage	Vin	-0.3	V _{DD} +0.3	V
Supply Current	$I_{DD}(Ta = 25^{\circ}C)$		60	mA
(Without Backllight)				
Supply Current for Backlight	$I_F(Ta = 25^{\circ}C)$		120	mA
Reverse Voltage for Backlight	$V_R(Ta = 25^{\circ}C)$		5.5	V
Operating Temperature	Тор	-20	70	$^{\circ}$ C
Storage Temperature	Tst	-30	80	$^{\circ}$ C

7. ELECTRICAL CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	V _{DD} -V _{SS}	$Ta = 25^{\circ}C$	3.0	3.3	3.6	V
Input High Voltage	V_{IH}	$Ta = 25^{\circ}C$	$0.8V_{\mathrm{DD}}$		V_{DD}	V
Input Low Voltage	VIL	$Ta = 25^{\circ}C$	0		$0.2V_{\mathrm{DD}}$	V
Output High Voltage	Voh	$Ta = 25^{\circ}C$	$0.8V_{\mathrm{DD}}$		V_{DD}	V
Output Low Voltage	Vol		0		$0.2V_{\mathrm{DD}}$	V
Supply Current	Idd	Ta = 25°C		50	60	mA
(Without Backllight)						

8. BACKLIGHT CHARACTERISTICS

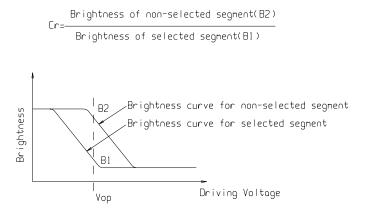
 $Ta = 25^{\circ}C$

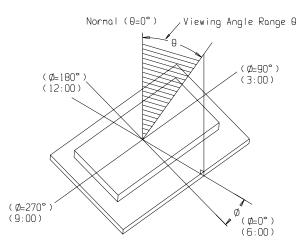
Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF	Vled=5.0V		5.0		V
Reverse Current	IR	Vled=5.0V		90	120	mA
Luminous Intensity (With	IV	Vled=5.0V	150	200		Cd/m ²
LCD dots off)						
LED Backlight Color	White					

9. ELECTRO-OPTICAL CHARACTERISTICS

 $(VDD=3.3V,Vled=5.0V,Ta=25^{\circ}C)$

Item	Symbol	Condition	Min	Тур	Max	Unit
	Θ L	Φ=180°(9 o'clock)	45	60		
Viewing angle	θR	Φ=0°(3 o'clock)	45	60		
(CR≥10)	θ T	Φ=90°(12 o'clock)	35	50		degree
	θв	Φ=270°(6 o'clock)	40	55		
Dagnanga tima	Ton			10	20	ms
Response time	Toff	Normal		15	25	ms
Contrast ratio	Cr	θ=Ф=0°	150	300		
Luminance	L1		150	200		Cd/m2





10. TIMING CHARACTERISTICS

10.1 Interface Timing

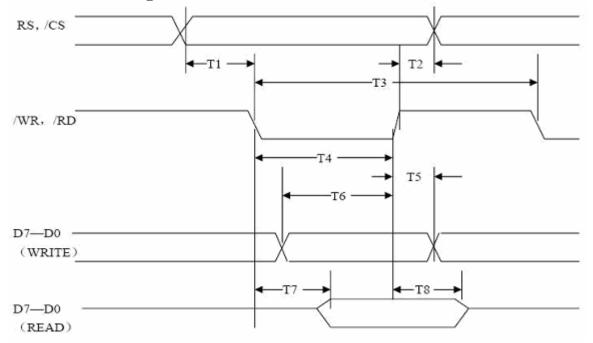


Figure 4. 8080 family Interface Timing



10.2 MCU Interface

Signal	Symbol	Parameter	VDD	=3.3V	Unit	Condition
Signai	Symbol	i didilictor	Min	Max	Omi	Condition
RS,/CS	T2	Address hold time	10	-	ns	
115,705	T1	Address setup time	0	-	ns	
/WR,/RD	Т3	System cycle time	350	-	ns	
/ // // // // // // // // // // // // /	T4	Strobe pulsewidth	180	-	ns	CL=100p
	T5	Data hold time	80	-	ns	F
D0-D7	Т6	Data setup time	120	-	ns	
Do Di	Т7	/RD Access time	-	50	ns	
	Т8	Output disable time	10	50	ns	

11. CONTROL AND DISPLAY INSTRUCTION

11.1 Instruction

/CS	RS	/WR	/RD	DB0~DB7	
Н	H/L	H/L	H/L	Command non-active	
L	L	L	Н	Write display data	
				Write Address(X,Y)	
L	Н	L	Н	X_Address: 0~319	
				Y_Address: 0~239	
L	L	Н	L	Command non-active	
L	Н	Н	L	Read display data	

Example:

wcomd(0x00); wcomd(0x00); wcomd(0x00); wdata(0xe0); //display red

X-Address(H), X-Address(L), Y-Address, Display data

Continuum write display data, Address is increased by 1 automatically.

11.2 Display Data format(256 Colors)

DB7	DB6	DB5	DB4	DB3	DB	32	DB1	DB0
R2	R1	R0	G2	2 (31	G0	B1	B0
MSB		LSB	MS	В		LSB	MSB	LSB
RED (000~111)			(GREEN(000~111)			BLUE(00~11)	

11.3 Porgram Example

```
//----- MCU: 89C52, 24M ------
#include <reg51.h>
#define uint unsigned int
#define uchar unsigned char
sbit CS = P3^2;
sbit RS = P3^3;
sbit WRR = P3<sup>4</sup>;
sbit RDD = P3^5;
sbit RST = P3^6;
void wcomd(uchar ch)
 CS=0;RDD=1;RS=0;
 P1=ch;
 WRR=0;
 WRR=1;
 CS=1;
void wdata(uchar ch)
 CS=0;RDD=1;RS=1;
 P1=ch;
 WRR=0;
 WRR=1;
 CS=1;
unsigned char rdata(void)
 uchar ch;
 CS=0;WRR=1;RS=1;
```

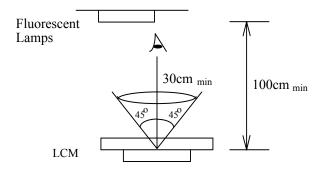
```
P1=0xff;
 RDD=0;
 ch=P1;
 RDD=1;
 CS=1;
 return(ch);
void waddr(uint xdat,uint ydat)
 uint xxh,xxl;
  xxh=xdat/256;
 xxl=xdat%256;
 wcomd(xxh);
 wcomd(xxl);
 wcomd(ydat);
void disp all(uchar xsdata)
 uint j,k;
 waddr(0x00,0x00);
 for(k=0;k<240;k++)
   for(j=0;j<320;j++)
   { wdata(xsdata);}
}
}
void main(void)
  RST=0;delay(50);RST=1;delay(20);
  while(1)
  {
   disp all(0xff); delay(200);
                                 //white
   disp_all(0x00); delay(200);
                                 //black
   disp_all(0xe0); delay(200);
                                 //red
   disp_all(0x1c); delay(200);
                                 //green
   disp_all(0x03); delay(200);
                                 //blue
   disp_all(0xfc); delay(200);
                                 //yellow
 }
}
```

12.QUALITY SPECIFICATIONS

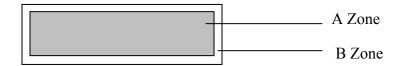
12.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: Active display area (minimum viewing area). B Zone: Non-active display area (outside viewing area).



12.2 Specification of quality assurance

AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification (Note: * is not including)

Classify	Item		Note	AQL
Major	Display state	Short or open circuit	1	0.65
		LC leakage		
	No display			
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	1
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display	Background color deviation	2	1.0
	state	Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
		Protruded	12	
	Polarizer	Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	B Position, Bonding strength		



Note on defect classification

No.	Item	Criterion				
1	Short or open circuit		Not allow			
	LC leakage					
	Flickering					
	No display					
	Wrong viewing direction					
	Wrong Back-light					
2	Contrast defect		Refer to approval sample			
	Background color deviation					
3	Point defect, Black spot, dust	↑Y			Point Size	Acceptable Qty.
	(including Polarizer)	Ϋ́X́		φ <u><</u> 0.10		Disregard
				0	.10<φ≤0.20	3
	$\phi = (X+Y)/2$		-	0	.20<φ≤0.25	2
	Ψ (21 1)/2		-	0	.25<φ≤0.30	1
			φ>0.30 Unit: mm			0
4	4 Line defect,					
	G 4 1	$\bigcap $ W		Line		Acceptable Qty.
	Scratch		L		W	Digragard
		L	5.0>		0.015≥W 0.03≥W	Disregard
			5.0≥ 5.0≥		0.05≥W	2
			5.0>		0.1>W	1
					0.05 <w< td=""><td>Applied as point defect</td></w<>	Applied as point defect
			Unit: mm			
5	Rainbow	Not more than two color changes across the viewing area.				



No	Item	Criterion			
6	Chip Remark: X: Length direction Y: Short	Acceptable criterion $\begin{array}{c ccccccccccccccccccccccccccccccccccc$			
	direction Z: Thickness direction t: Glass thickness W: Terminal Width	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			
		Acceptable criterion $\begin{array}{c cccc} X & Y & Z \\ \hline \leqslant 3 & \leqslant 2 & \leqslant \dagger \\ \hline \text{shall not reach to ITO} \end{array}$			
		Acceptable criterion $\begin{array}{c ccccccccccccccccccccccccccccccccccc$			
		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			



No.	Item	Criterion			
7	Segment pattern $W = Segment \ width$ $\phi = (X+Y)/2$	(1) Pin hole $\phi < 0.10 \text{mm is acceptable.}$ X			
		Point Size Acceptable Qty			
8	Back-light	(1) The color of backlight should correspond its specification.			
9	Soldering	(2) Not allow flickering (1) Not allow heavy dirty and solder ball on PCB. (The size of dirty refer to point and dust defect) (2) Over 50% of lead should be soldered on Land. Lead Land 50% lead			
10	Wire	 (1) Copper wire should not be rusted (2) Not allow crack on copper wire connection. (3) Not allow reversing the position of the flat cable. (4) Not allow exposed copper wire inside the flat cable. 			
11*	PCB	(1) Not allow screw rust or damage.(2) Not allow missing or wrong putting of component.			



No	Item	Criterion			
12	Protruded W: Terminal Width	Acceptable criteria: $Y \le 0.4$			
13	TAB	1. Position $\begin{array}{cccccccccccccccccccccccccccccccccccc$			
		2 TAB bonding strength test TAB P (=F/TAB bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)			
14	Total no. of acceptable Defect	A. Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm B. Zone It is acceptable when it is no trouble for quality and assemblin customer's end product.			

12.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80°C	48	
High temp. Operating	70°C	48	
Low temp. Storage	-30°C	48	No abnormalities
Low temp. Operating	-20°C	48	in functions
Humidity	40°C/ 90%RH	48	and appearance
Temp. Cycle	$-20^{\circ}\text{C} \leftarrow 25^{\circ}\text{C} \rightarrow 70^{\circ}\text{C}$	10cycles	
	$(30 \min \leftarrow 5 \min \rightarrow 30 \min)$		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance ,etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($20\pm8^{\circ}$ C), normal humidity (below $45\pm20\%$ RH), and in the area not exposed to direct sun light. The life time is not content the life time of the LED (for the life time of LED which decay only 50%,in the industry the experience value is 50000 hours, but there are not any experimentation data to support this).

12.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not make any modification on the PCB without consulting AV.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.



- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280°C+10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.



Limited Warranty

AV LCDs and modules are not consumer products, but may be incorporated by AV's customers into consumer products or components thereof, AV does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of AV is limited to repair or replacement on the terms set forth below. AV will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between AV and the customer, AV will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with AV general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.